

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Chung-Hsing CHANG</td> <td>01/13/2010</td> </tr> <tr> <td>Wen-Yi CHEN</td> <td>12/31/2009</td> </tr> <tr> <td>Chia-Liang LIN</td> <td>01/13/2010</td> </tr> </tbody> </table>		Name	Execution Date	Chung-Hsing CHANG	01/13/2010	Wen-Yi CHEN	12/31/2009	Chia-Liang LIN	01/13/2010
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<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>Dynapack International Technology Corp.</td> </tr> <tr> <td>Street Address:</td> <td>3F, No. 66, Hwa-Ya 1st Rd., Hwa-Ya Technology Park, Guei-Shan Hsiang</td> </tr> <tr> <td>City:</td> <td>Taoyuan</td> </tr> <tr> <td>State/Country:</td> <td>TAIWAN</td> </tr> </table>		Name:	Dynapack International Technology Corp.	Street Address:	3F, No. 66, Hwa-Ya 1st Rd., Hwa-Ya Technology Park, Guei-Shan Hsiang	City:	Taoyuan	State/Country:	TAIWAN
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PROPERTY NUMBERS Total: 1									
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CORRESPONDENCE DATA									
<p>Fax Number: (206)203-2603</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 301-840-3885</p> <p>Email: MCHOW@SINORICA.COM</p> <p>Correspondent Name: SINORICA, LLC</p> <p>Address Line 1: 2275 Research Blvd.</p> <p>Address Line 2: Suite 500</p> <p>Address Line 4: ROCKVILLE, MARYLAND 20850</p>									
ATTORNEY DOCKET NUMBER:	TW-RNA-0632								
NAME OF SUBMITTER:	Ming Chow								
<p>Total Attachments: 2</p> <p>source=assignment_TWRNA0632#page1.tif</p> <p>source=assignment_TWRNA0632#page2.tif</p>									

OP \$40.00 12785145

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PATENT
REEL: 024425 FRAME: 0530

ASSIGNMENT

FOR GOOD AND VALUABLE CONSIDERATION given
 to (1) Chung-Hsing Chang (2) Wen-Yi Chen (3) Chia-Liang Lin
 having post office address
 of 3F, No. 66, Hwa-Ya 1st Rd., Hwa-Ya Technology Park, Guei-Shan Hsiang, Taoyuan, Taiwan, R.O.C.
 3F, No. 66, Hwa-Ya 1st Rd., Hwa-Ya Technology Park, Guei-Shan Hsiang, Taoyuan, Taiwan, R.O.C.,
 hereinafter referred to as the ASSIGNOR(S), who has/have
 invented certain new and useful
 „ Charging Method And Charging Device For Charging A Rechargeable Battery „
 hereinafter referred to as the invention, for which I/we
 has/have executed an application for Letters Patent to be filed
 in the United States Patent and Trademark Office.

WHEREAS, Dynapack International Technology Corp.,
 corporation(s) organized and existing under the laws of the
 country/state of Taiwan, R.O.C., whose post
 office address/business address(es)
 is/are 3F, No. 66, Hwa-Ya 1st Rd., Hwa-Ya Technology Park,
Guei-Shan Hsiang, Taoyuan, Taiwan, R.O.C.,
 hereinafter referred to as the ASSIGNEE, desires to acquire the
 entire right, title and interest for the United States and
 elsewhere throughout the world in and to said invention and
 application, including any and all divisions and continuations
 thereof, all rights of priority under the terms of the
 International Convention for the Protection of Industrial
 Property, and any and all Letters Patent which may be granted
 thereon, including any and all renewals, reissues and
 prolongations thereof.

NOW, WITNESSETH THIS that for and in consideration of the
 sum of one dollar (\$1.00) and other good and valuable
 consideration, the receipt, adequacy and sufficiency of which
 are hereby acknowledged, said ASSIGNOR(S) hereby assign(s),
 sell(s) and transfer(s) to said ASSIGNEE(S), its assigns and
 legal representatives, the entire right, title and interest for
 the United States and elsewhere throughout the world, in and
 to said invention and application, including any and all
 divisions and continuations thereof, all rights of priority
 under the terms of the International Convention for the

Protection of Industrial Property, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges, and advantages in any way arising from or pertaining thereto, for and during the term or terms of any and all such Letters Patent when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said ASSIGNEE(S) and its assigns and legal representatives, in as ample and as beneficial a manner for all intents and purposes as said ASSIGNOR(S) might or could have held and enjoyed the same had this assignment not been made.

ALSO, said ASSIGNOR(S) hereby agree(s) to execute all papers necessary to file said applications in the United States and elsewhere throughout the world, and to assign the same to said ASSIGNEE(S), or any assignee acquiring title to said invention, and to execute any other papers that may be needed in connection with filing said application and securing any and all Letters Patent thereon.

AND said ASSIGNOR(S) authorize(s) and request(s) the Commissioner of Patents to issue a Letters Patent on said application, and on any and all divisions and continuations thereof, to said ASSIGNEE(S), its assigns and legal representatives, in accordance herewith.

By:	<u>Chung-Hsing Chang</u>	<u>Jan. 13, 2010</u>
	(1) Inventor's Name	Date
By:	<u>Wen-Yi Chen</u>	<u>Dec. 31, 2009</u>
	(2) Inventor's Name	Date
By:	<u>Chia-Liang Lin</u>	<u>Jan. 13, 2010</u>
	(3) Inventor's Name	Date
By:	_____	_____
	(4) Inventor's Name	Date
By:	_____	_____
	(5) Inventor's Name	Date